

1.6x0.8x0.25mm (0603) SMD CHIP LED LAMP



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE **DEVICES**

Part Number: APG1608SURKC/T Hyper Red

Features

- 1.6mmX0.8mm SMD LED, 0.25mm thickness.
- Low power consumption.
- Wide viewing angle.
- Compatible with automatic placement equipment.
- Ideal for backlight and indicator.
- Package: 4,000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

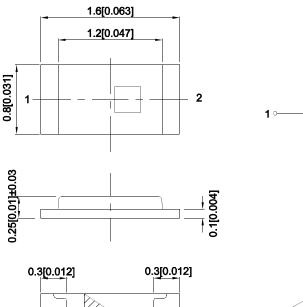
Descriptions

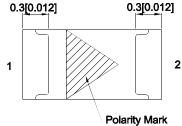
- The Hyper Red source color devices are made with Al GaInP on GaAs substrate Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipment and machinery must be electri cally grounded.

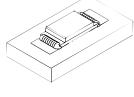
Applications

- 1. Mobile phone Keypad indicator and backlight.
- 2.Flat backlight for LCD, switch and symbol.
- 3.Toys.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
APG1608SURKC/T	Lhwan Dad (AlCalaD)	Water Clear	200	350	- 120°
	Hyper Red (AlGaInP)		*55	*110	

Notes:

- $1. \theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
 Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	645		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	630		nm	I==20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	2	2.5	V	IF=20mA
lr	Reverse Current	Hyper Red		10	uA	V _R =5V

- Notes: 1.Wavelength: +/-1nm. 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to CIE127-2007 standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

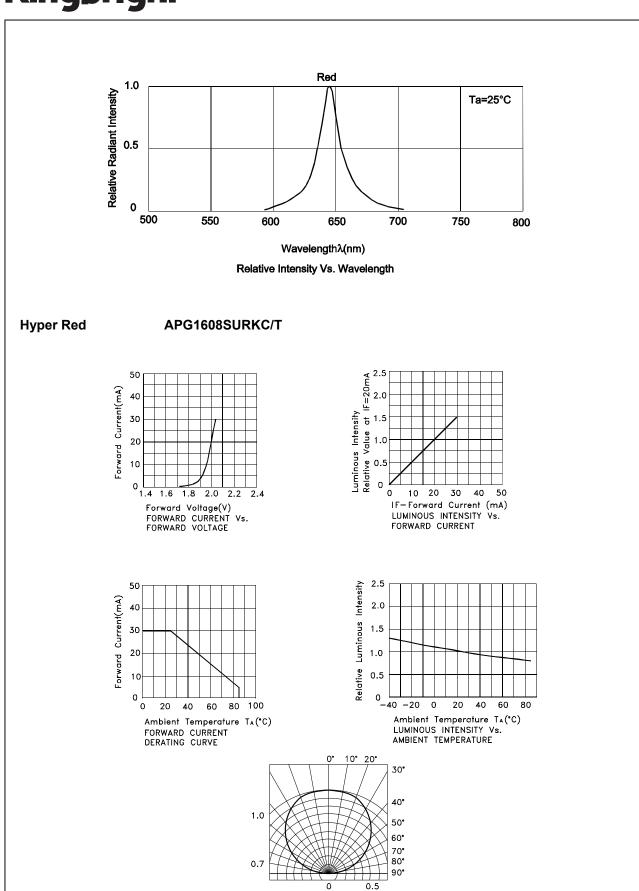
Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Notes:

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity - Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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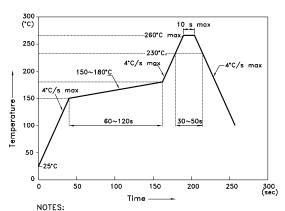
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SPATIAL DISTRIBUTION

APG1608SURKC/T

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

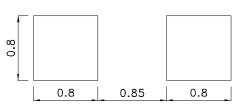
Reflow Soldering Profile For Lead-free SMT Process.



- NOTES: 1.We recommend the reflow temperature 245°C(\pm /-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

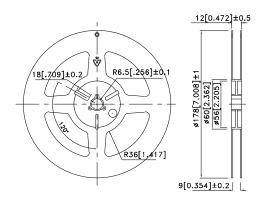
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

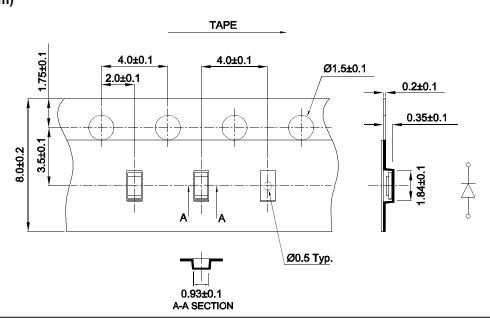


Mask open area ratio:80% Mask thickness:80~100um

Reel Dimension



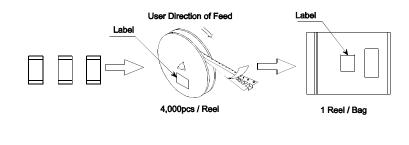
Tape Dimensions (Units : mm)

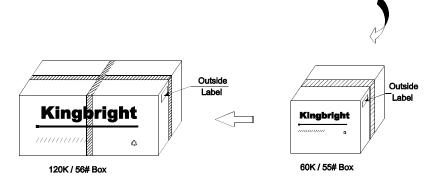


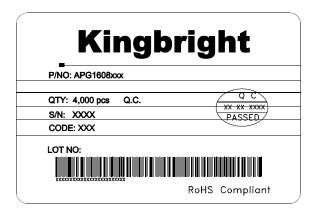
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PACKING & LABEL SPECIFICATIONS

APG1608SURKC/T







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